

Model	No.:
Date /	Rev.

FYLP-1W-IRCCB 2023.03.16 / A

PRODUCT SPECIFICATION

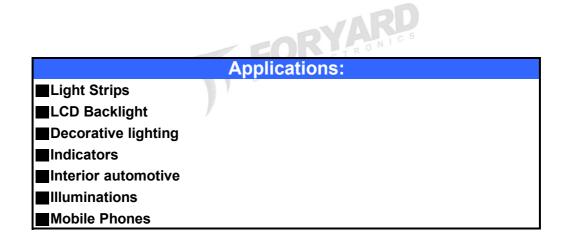
Model No.: FYLP-1W-IRCCB

Features:

SMD	Туре
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- Size (mm):15.00*8.00*5.20
- Emitting Color:Infrared
- SMT package
- Suitable for all SMT assembly and soldering method
- Pb-free Reflow soldering application
- RoHS Compliant

MSL:6





CUSTOMER APPROVED SIGNATURES	APPROVED BY	SALES BY	PREPARED BY
		Foryard S020 2023. 03. 16	Foryard E001 2023, 03, 16

NINGBO FORYARD OPTOELECTRONICS CO., LTD.

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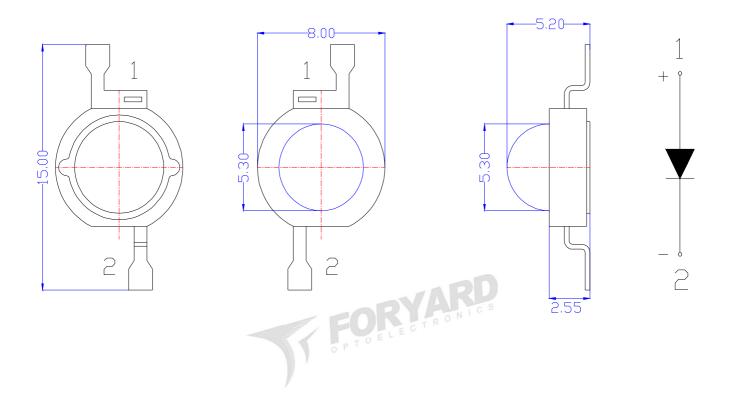
<u>Http://www.foryard.com</u>

Zip:315103

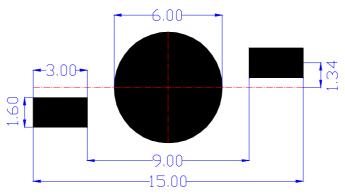


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Mechanical Dimensions



Recommend Soldering pad design(unit=mm)



Notes:

1. Dimension in millimeter, tolerance is ± 0.10 .

2.Angle:±5°

3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

4. The drawing is different from the actual one, please refer to the sample.



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Absolute Maximun Ratings(Ta=25°C)

Parameter	Symbol	MAX.	Unit
Power Dissipation	PD	1500	mW
Continuous Forward Current	IF	750	mA
Peak Forward Current*	IFP	1200	mA
Reverse Voltage	VR	5	V
Operating Temperature Range	Topr	-25~ +80	°C
Storage Temperature Range	Tstg	-25~ +100	°C

*1/10 Duty Cycle, 0.1ms Pulse Width

■ Typical Electrical &Optical Charcteristics(Ta=25°C)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Radiant Intensity	Ee	IF=600mA	280	330		mW/sr
Forward Voltage	VF	IF=600mA	1.5	1.7	2	V
Dominant Wavelength	λd	IF=600mA	840	855	865	nm
Spectral Line Half-Width	Δλ	IF=600mA		40		nm
Backward Voltage	IR	VR = 5V			10	μA
Viewing Angle	2θ _{1/2}	IF=600mA	RONI	120		Deg
Material		PTOELL				

Material

ſ	Item	Reflector	Wire	Encapsulate	Chip
	Material	PPA	Gold	Silicon	AlGaAs

Note:

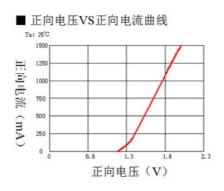
1.Luminous Intensity is based on the Foryard standards.

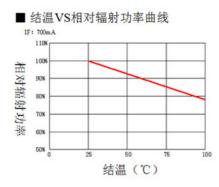
2.Pay attention about static for InGaN



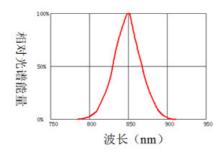
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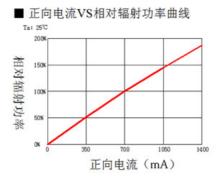
Electrical-Optical Characteristics-

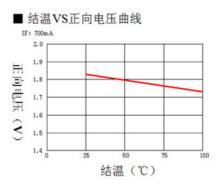


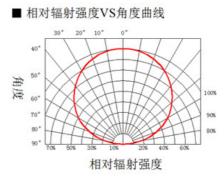












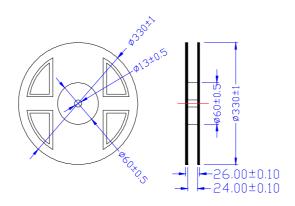
NOTE:25°C free air temperature unless otherwise specified



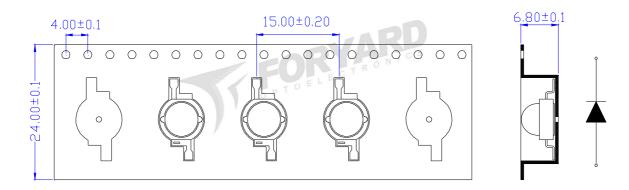
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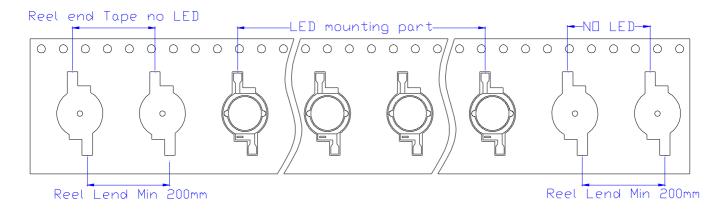
Package-

1. Reel Dimension



2. Tape Dimension





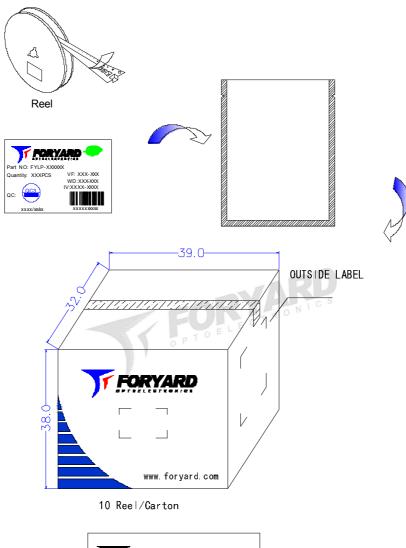
Notice:

1. Tolerance unless mentioned is \pm 0.2mm



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3.Packing Diagram





OUTSIDE LABEL

Notice:

1.Quantity:1000 PCS/Reel

2. The specifications are subject to change without notice. Please contact us for updated information.

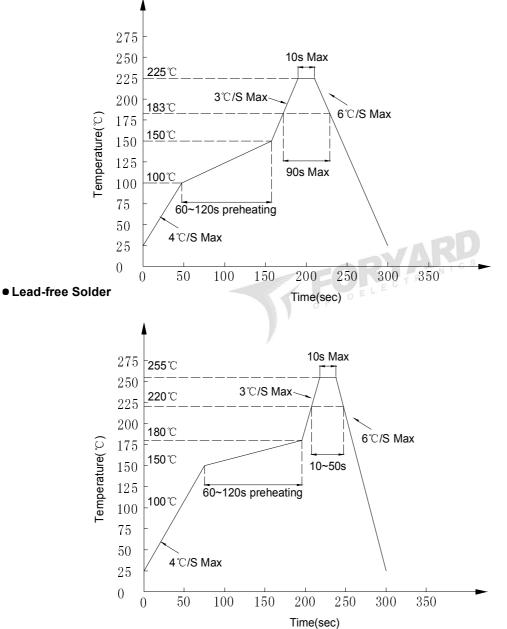


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Soldering Characteristics-

Reflow Soldering

Lead Solder



Notes:

1.Although the recommended soldering conditions are specified in above table, reflow or hand soldering at the lowest possible temperature is desired for the LEDs.

2.A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

3.All temperatures refer to solder Pad.

Hand Soldering

Soldering temperature	300℃ Max. (25W Max.)	One time olny
Soldering time	5 ±1sec	



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Handling of Silicone Resin LEDs-

Handling Indications

When handling the product, do not touch it directly with bare hands as it may contaminate the surface and affect on optica characteristics. In the worst cases, excessive force to the product might result in catastrophic failure due to package damage and/or wire breakage.

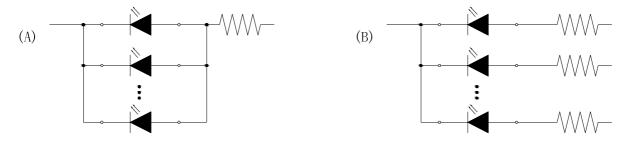


When handling the product with tweezers, LEDs should only be handled from the side and make sure that excessive force is not applied to the resin portion of the pordct. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed, and wire to be broken, and thus resulting in catastrophic failure.



Recommended circuit-

• In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LEC It is recommended to use Circuit B which regulates the current flowing through each LED. In the meanwhile, when driving LE with a constant voltage in Circuit A, the current through the LEDs may vary due to the variation in forward voltage(VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the absolute maximum rating.



• This product should be operated in forward bias. A driving circuit must be designed so that the product is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the product; such operation can cause migration resulting in LED damage.

Storage-

Storage Conditions

1. Unopened moisture barrier bag (MBB) shall be stored at temperature below $5^{\circ}C \sim 30^{\circ}C$, with humidity below $60^{\circ}RH$. 2. Before the MBB be opened, check if have the air leakage, if have, then need to bake at $65^{\circ}C \sim 70^{\circ}C$ for 24 hours.

- 3.After the MBB has been opened, the LEDs which need for reflow soldering or other soldering methods, must be used according to below:
 - a: Must finish the soldering in 12hours
 - b: Stored with the humidity below 30%RH
 - c: If not finish the soldering in 12hours, need to bake the LED again at $65\,^\circ\!C$ ~70 $^\circ\!C$ for 24hours